

C0603X224J4RACTU

Aliases (C0603X224J4RAC7867) SMD Comm X7R Flex, Ceramic, 0.22 uF, 5%, 16 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 0603, 0.4 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X7R Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Temperature Stable
Features	FT-CAP, Temperature Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	7.3 mg
Shelf Life	78 Weeks
MSL	1

	Specifications	
0603	Capacitance	0.22 uF
1.6mm +/-0.17mm	Measurement Condition	1 kHz 1.0Vrms
0.8mm +/-0.15mm	Tolerance	5%
0.8mm +/-0.15mm	Voltage DC	16 VDC
0.4mm MIN	Dielectric Withstanding Voltage	40 VDC
0.45mm +/-0.15mm	Temperature Range	-55/+125°C
	Temp. Coefficient	X7R
	Capacitance Change with 15%, 1kHz 1.0V	15%, 1kHz 1.0Vrms
T&R, 180mm, Paper Tape	Reference to +25°Č and 0 VDC Applied (TCC)	
4000	Dissipation Factor	5%1kHz1.0Vrms

Aging Rate

Insulation Resistance

Chip Size L W т s в

Packaging Specifications

Dimensions

Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	4000

3% Loss/Decade Hour: Referee

Time is 1000 Hours

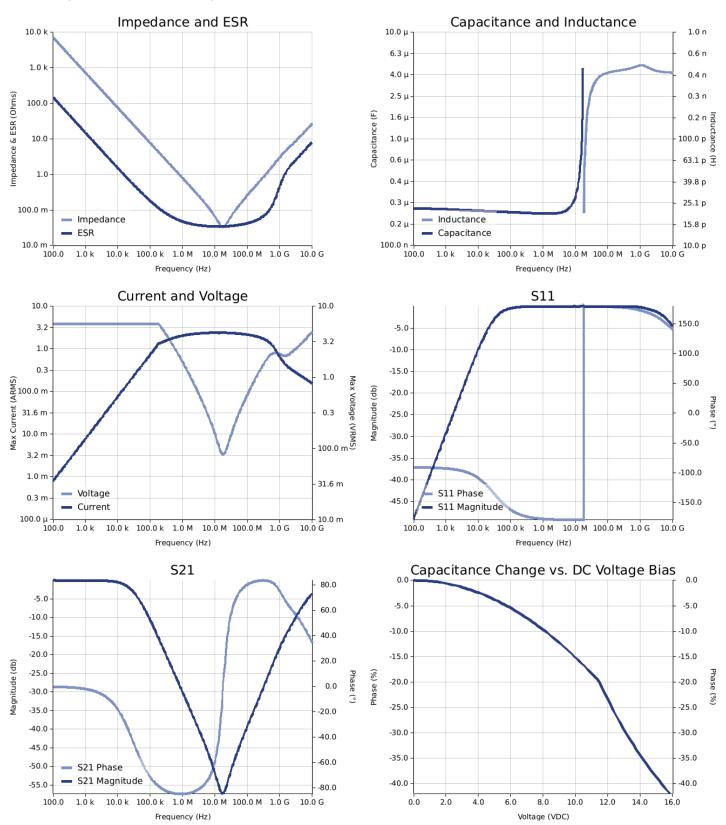
2.2727 GOhms



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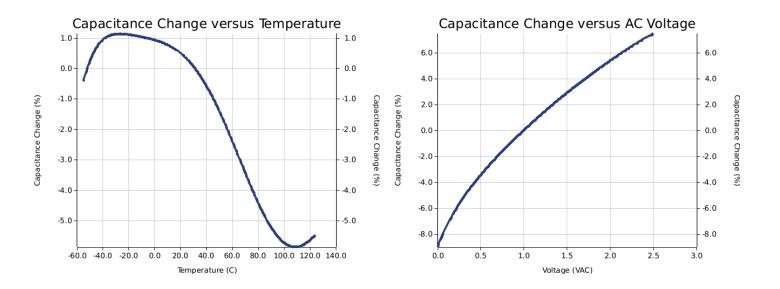
Simulations

For the complete simulation environment please visit K-SIM.





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These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.

- The ESR used for hipple klipple current/ voltage vs. requericy plots is the ESR at an originatine.
 The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
 The effects shown herein are based on measured data from a multiple part sample of the parts in question.
 Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.
 The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages are applied to reach previous the burger of the parts.
- generated at any other harmonics. Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.